

# 3.3 V ECL ÷2, ÷4, ÷8 Clock Generation Chip

## MC100LVEL34

### Description

The MC100LVEL34 is a low skew ÷2, ÷4, ÷8 clock generation chip designed explicitly for low skew clock generation applications. The internal dividers are synchronous to each other, therefore, the common output edges are all precisely aligned. The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01  $\mu\text{F}$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

The common enable ( $\overline{\text{EN}}$ ) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is already in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. An internal runt pulse could lead to losing synchronization between the internal divider stages. The internal enable flip-flop is clocked on the falling edge of the input clock; therefore, all associated specification limits are referenced to the negative edge of the clock input.

Upon start-up, the internal flip-flops will attain a random state; the master reset (MR) input allows for the synchronization of the internal dividers, as well as multiple LVEL34s in a system.

### Features

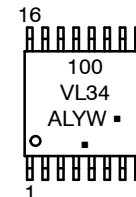
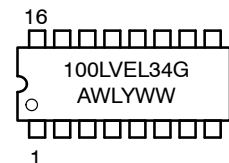
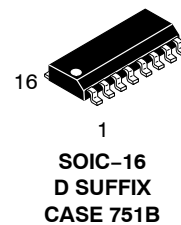
- 50 ps Typical Output-to-Output Skew
- Synchronous Enable/Disable
- Master Reset for Synchronization
- 1.5 GHz Toggle Frequency
- The 100 Series Contains Temperature Compensation.
- PECL Mode Operating Range:  
 $V_{CC} = 3.0 \text{ V to } 3.8 \text{ V with } V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range:  
 $V_{CC} = 0 \text{ V with } V_{EE} = -3.0 \text{ V to } -3.8 \text{ V}$
- Open Input Default State
- LVDS Input Compatible
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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### MARKING DIAGRAMS\*



A = Assembly Location  
L, WL = Wafer Lot  
Y = Year  
W, WW = Work Week  
G or ■ = Pb-Free Package

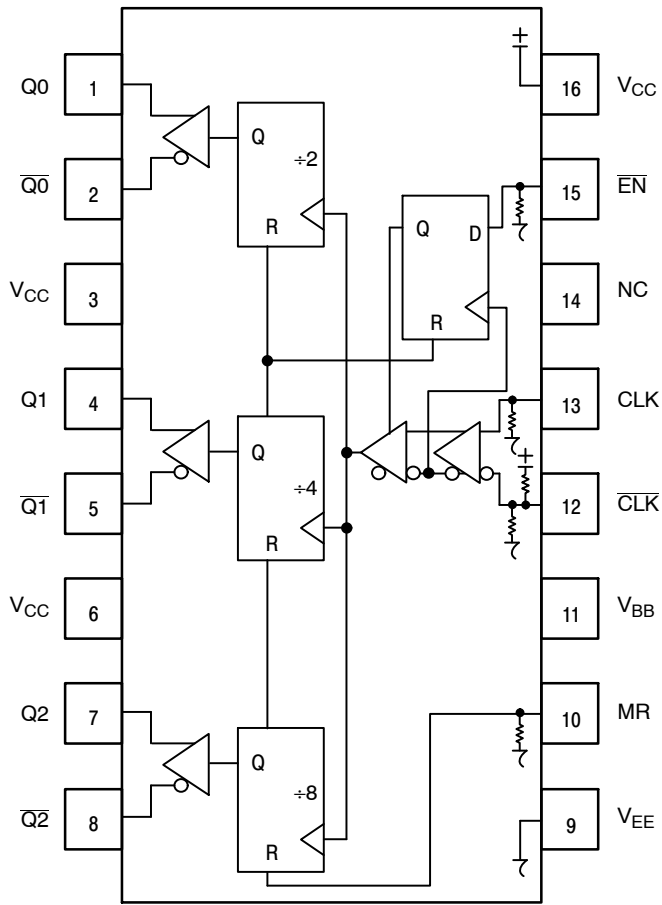
(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note [AND8002/D](#).

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

# MC100LEVEL34



Warning: All V<sub>CC</sub> and V<sub>EE</sub> pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. 16-Lead Pinout (Top View) and Logic Diagram

Table 1. PIN DESCRIPTION

PIN	FUNCTION
CLK*, $\overline{\text{CLK}}^{**}$	ECL Diff Clock Inputs
EN*	ECL Sync Enable
MR*	ECL Master Reset
Q0, $\overline{\text{Q0}}$	ECL Diff +2 Outputs
Q1, $\overline{\text{Q1}}$	ECL Diff +4 Outputs
Q2, $\overline{\text{Q2}}$	ECL Diff +8 Outputs
V <sub>BB</sub>	Reference Voltage Output
V <sub>CC</sub>	Positive Supply
V <sub>EE</sub>	Negative Supply
NC	No Connect

\* Pins will default LOW when left open.

\*\*Pins will default to V<sub>CC</sub>/2 when left open.

Table 2. FUNCTION TABLE

CLK	EN	MR	FUNCTION
Z	L	L	Divide
ZZ	H	L	Hold Q <sub>0-3</sub>
X	X	H	Reset Q <sub>0-3</sub>

Z = Low-to-High Transition

ZZ = High-to-Low Transition

Table 3. ATTRIBUTES

Characteristics	Value
Internal Input Pulldown Resistor	75 k $\Omega$
Internal Input Pullup Resistor	37.5 k $\Omega$
ESD Protection Human Body Model Machine Model Charged Device Model	> 2 kV > 200 V > 2 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)	Pb-Free Pkg
SOIC-16 TSSOP-16	Level 1 Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count	210 Devices
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

1. For additional information, see Application Note [AND8003/D](#).

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**Table 4. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		6	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-6	V
V <sub>I</sub>	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	V <sub>I</sub> ≤ V <sub>CC</sub> V <sub>I</sub> ≥ V <sub>EE</sub>	6 -6	V V
I <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source			± 0.5	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
θ <sub>JA</sub>	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-16 SOIC-16	100 60	°C/W °C/W
θ <sub>JC</sub>	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-16	33 to 36	°C/W
θ <sub>JA</sub>	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	TSSOP-16 TSSOP-16	138 108	°C/W °C/W
θ <sub>JC</sub>	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-16	33 to 36	°C/W
T <sub>sol</sub>	Wave Solder			265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**Table 5. 100LVEL DC CHARACTERISTICS, PECL (V<sub>CC</sub> = 3.3 V, V<sub>EE</sub> = 0 V (Note 2))**

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>EE</sub>	Power Supply Current	40	50	60	40	50	60	42	52	62	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 3)	2155	2280	2405	2155	2280	2405	2155	2280	2405	mV
V <sub>OL</sub>	Output LOW Voltage (Note 3)	1305	1570	1725	1305	1570	1725	1305	1570	1725	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	2075		2420	2075		2420	2075		2420	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	1305		1675	1305		1675	1305		1675	mV
V <sub>BB</sub>	Output Voltage Reference	1775	1875	1975	1775	1875	1975	1775	1875	1975	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4)	1.2		3.3	1.2		3.3	1.2		3.3	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
I <sub>IL</sub>	Input LOW Current										μA
	D	0.5			0.5			0.5			
	$\bar{D}$	-150			-150			-150			

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

2. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.925 V to -0.5 V.

3. All loading with 50 Ω to V<sub>CC</sub> - 2.0 V.

4. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

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**Table 6. 100LEVEL DC CHARACTERISTICS, NECL** ( $V_{CC} = 0\text{ V}$ ,  $V_{EE} = -3.8\text{ V}$  to  $-3.0\text{ V}$  (Note 5))

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$I_{EE}$	Power Supply Current	23	30	40	23	30	40	23	30	40	mA
$I_{EE}$	Power Supply Current	40	50	60	40	50	60	42	52	62	mA
$V_{OH}$	Output HIGH Voltage (Note 6)	-1145	-1020	-895	-1145	-1020	-895	-1145	-1020	-895	mV
$V_{OL}$	Output LOW Voltage (Note 6)	-1995	-1700	-1575	-1995	-1700	-1575	-1995	-1700	-1575	mV
$V_{IH}$	Input HIGH Voltage (Single-Ended)	-1225		-880	-1225		-880	-1225		-880	mV
$V_{IL}$	Input LOW Voltage (Single-Ended)	-1995		-1625	-1995		-1625	-1995		-1625	mV
$V_{BB}$	Output Voltage Reference	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
$V_{IHCMR}$	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 7)	$V_{EE} + 1.2$		0.0	$V_{EE} + 1.2$		0.0	$V_{EE} + 1.2$		0.0	V
$I_{IH}$	Input HIGH Current			150			150			150	$\mu\text{A}$
$I_{IL}$	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			$\mu\text{A}$

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm.

5. Input and output parameters vary 1:1 with  $V_{CC}$ .

6. All loading with  $50\ \Omega$  to  $V_{CC} - 2.0\text{ V}$ .

7.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ ,  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal.

**Table 7. AC CHARACTERISTICS**  $V_{CC} = 0\text{ V}$ ;  $V_{EE} = -3.0\text{ V}$  to  $-5.5\text{ V}$  or  $V_{CC} = 3.0\text{ V}$  to  $5.5\text{ V}$ ;  $V_{EE} = 0\text{ V}$  (Note 8)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{max}$	Maximum Toggle Frequency (Figure 4)	1.5			1.5			1.5			GHz
$t_{PLH}$ $t_{PHL}$	Propagation Delay to Output CLK to Q0, Q1, Q2 MR to Q	550 500	650 600	1000 1000	600 550	700 650	1000 1000	650 600	750 700	1000 1000	ps
$t_{JITTER}$	Cycle-to-Cycle Jitter (Figure 4)		< 1			< 1			< 1		ps
$t_S$	Setup Time $\overline{EN}$	150	50		150	50		150	50		ps
$t_H$	Hold Time $\overline{EN}$	200	100		200	100		200	100		ps
$t_{RR}$	Set/Reset Recovery	300	200		300	200		300	200		ps
$V_{PP}$	Input Swing (Note 9)	150		1000	150		1000	150		1000	mV
$t_r$ $t_f$	Output Rise/Fall Times Q (20% – 80%)	120	170	400	140	180	400	160	200	400	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm.

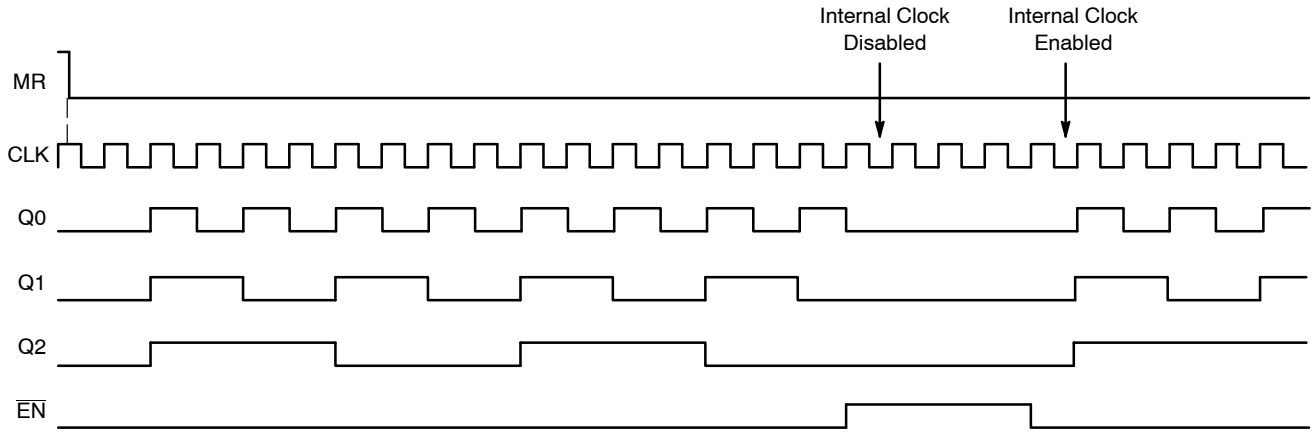
8. Measured using a 750 mV source, 50% duty cycle clock source. All loading with  $50\ \Omega$  to  $V_{CC} - 2.0\text{ V}$ .

9.  $V_{PP}(\text{min})$  is minimum input swing for which AC parameters guaranteed. The device has a DC gain of  $\approx 40$ .

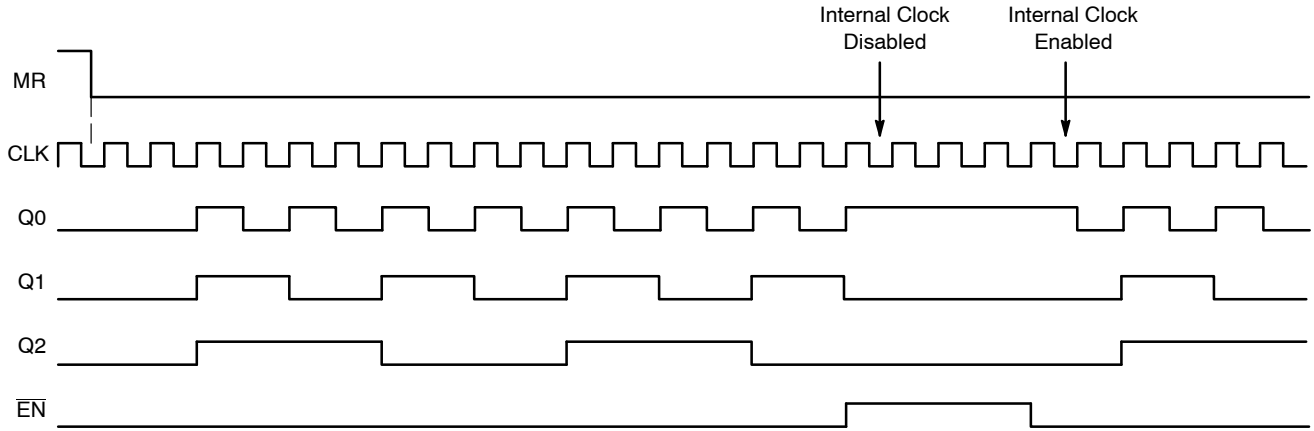
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# MC100LVEL34

There are two distinct functional relationships between the Master Reset and Clock:



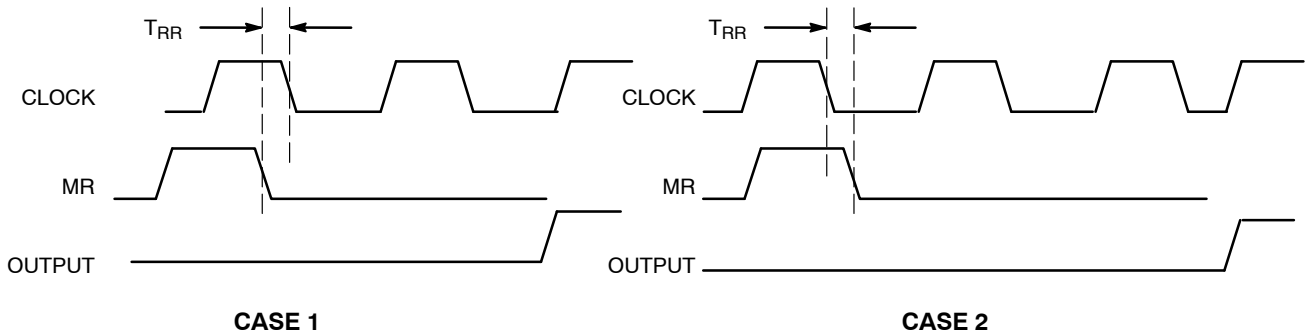
**CASE 1: If the MR is Deasserted (H-L), while the Clock is Still High, the Outputs will Follow the Second Ensuing Clock Rising Edge**



**CASE 2: If the MR is Deasserted (H-L), after the Clock has Transitioned Low, the Outputs will Follow the Third Ensuing Clock Rising Edge**

**Figure 2. Timing Diagrams**

The  $\overline{EN}$  signal will “freeze” the internal divider flip-flops on the first falling edge of CLK after its assertion. The internal divider flip-flops will maintain their state during the freeze. When  $\overline{EN}$  is deasserted (LOW), and after the next falling edge of CLK, then the internal divider flip-flops will “unfreeze” and continue to their next state count with proper phase relationships.



**Figure 3. Reset Recovery Time**

# MC100LVEL34

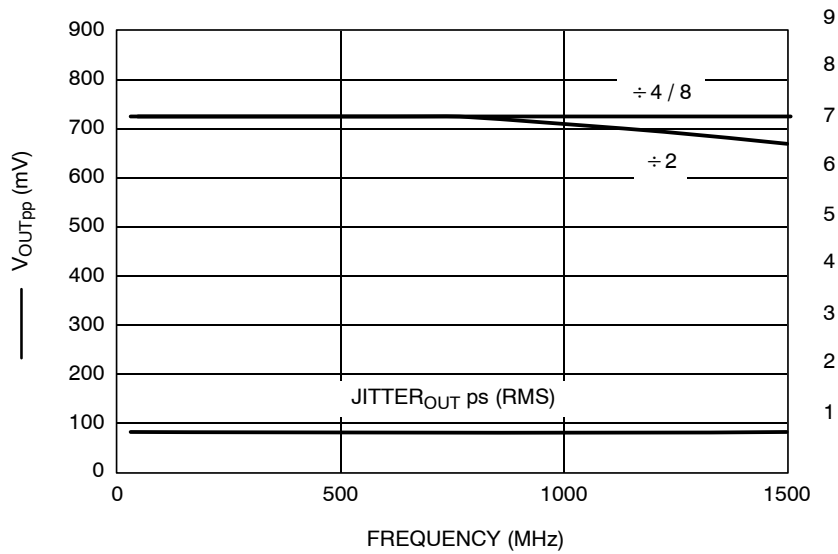


Figure 4.  $F_{max}/Jitter$

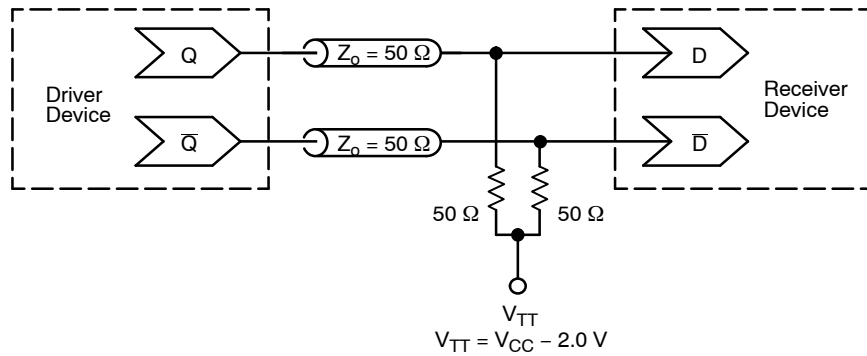


Figure 5. Typical Termination for Output Driver and Device Evaluation  
(See Application Note [AND8020/D](#) – Termination of ECL Logic Devices.)

# MC100LVEL34

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MC100LVEL34DR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel
MC100LVEL34DTG	TSSOP-16 (Pb-Free)	96 Units / Rail
MC100LVEL34DTR2G	TSSOP-16 (Pb-Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## Resource Reference of Application Notes

- AN1405/D** - ECL Clock Distribution Techniques
- AN1406/D** - Designing with PECL (ECL at +5.0 V)
- AN1503/D** - ECLinPS™ I/O SPICE Modeling Kit
- AN1504/D** - Metastability and the ECLinPS Family
- AN1568/D** - Interfacing Between LVDS and ECL
- AN1672/D** - The ECL Translator Guide
- AND8001/D** - Odd Number Counters Design
- AND8002/D** - Marking and Date Codes
- AND8020/D** - Termination of ECL Logic Devices
- AND8066/D** - Interfacing with ECLinPS
- AND8090/D** - AC Characteristics of ECL Devices

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# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

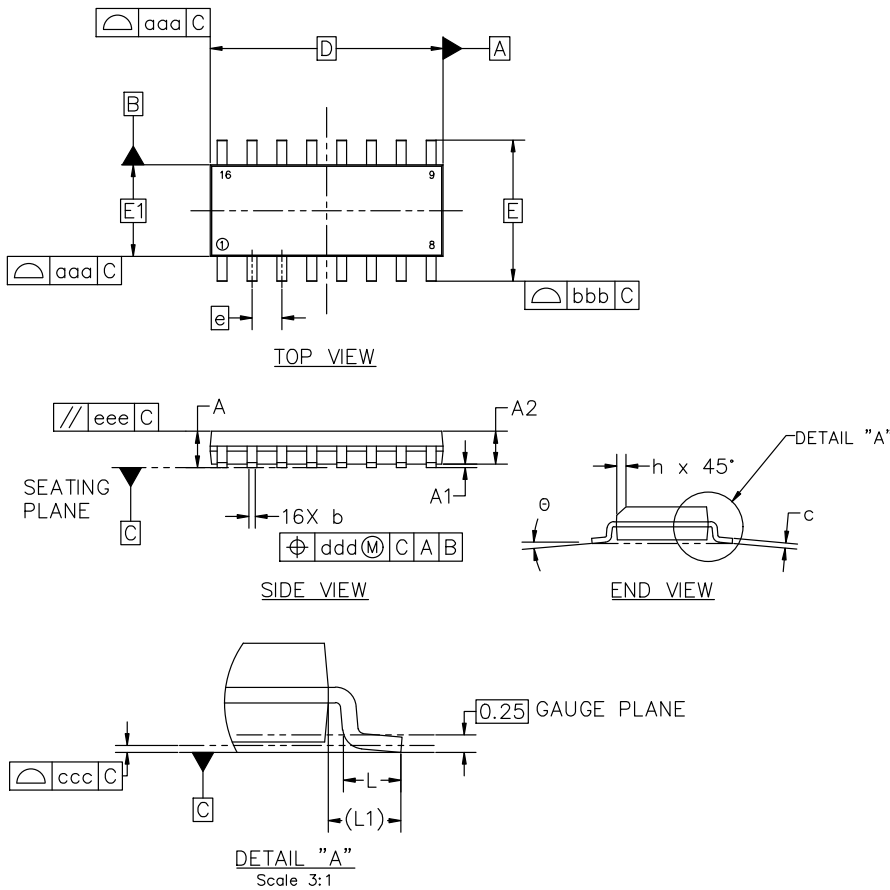


**SOIC-16 9.90x3.90x1.50 1.27P**  
**CASE 751B**  
**ISSUE L**

**DATE 29 MAY 2024**

**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.



MILLIMETERS			
DIM	MIN	NOM	MAX
A	1.35	1.55	1.75
A1	0.00	0.05	0.10
A2	1.35	1.50	1.65
b	0.35	0.42	0.49
c	0.19	0.22	0.25
D	9.90 BSC		
E	6.00 BSC		
E1	3.90 BSC		
e	1.27 BSC		
h	0.25	---	0.50
L	0.40	0.83	1.25
L1	1.05 REF		
θ	0°	---	7°
TOLERANCE OF FORM AND POSITION			
aaa	0.10		
bbb	0.20		
ccc	0.10		
ddd	0.25		
eee	0.10		



**RECOMMENDED MOUNTING FOOTPRINT**

\*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D

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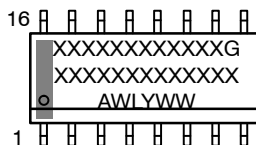
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**SOIC-16 9.90x3.90x1.50 1.27P**  
**CASE 751B**  
**ISSUE L**

DATE 29 MAY 2024

**GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code  
 A = Assembly Location  
 WL = Wafer Lot  
 Y = Year  
 WW = Work Week  
 G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

<p><b>STYLE 1:</b></p> <p>PIN 1. COLLECTOR          2. BASE          3. EMITTER          4. NO CONNECTION          5. EMITTER          6. BASE          7. COLLECTOR          8. COLLECTOR          9. BASE          10. EMITTER          11. NO CONNECTION          12. EMITTER          13. BASE          14. COLLECTOR          15. EMITTER          16. COLLECTOR</p>	<p><b>STYLE 2:</b></p> <p>PIN 1. CATHODE          2. ANODE          3. NO CONNECTION          4. CATHODE          5. CATHODE          6. NO CONNECTION          7. ANODE          8. CATHODE          9. CATHODE          10. ANODE          11. NO CONNECTION          12. CATHODE          13. CATHODE          14. NO CONNECTION          15. ANODE          16. CATHODE</p>	<p><b>STYLE 3:</b></p> <p>PIN 1. COLLECTOR, DYE #1          2. BASE, #1          3. EMITTER, #1          4. COLLECTOR, #1          5. COLLECTOR, #2          6. BASE, #2          7. EMITTER, #2          8. COLLECTOR, #2          9. COLLECTOR, #3          10. BASE, #3          11. EMITTER, #3          12. COLLECTOR, #3          13. COLLECTOR, #4          14. BASE, #4          15. EMITTER, #4          16. COLLECTOR, #4</p>	<p><b>STYLE 4:</b></p> <p>PIN 1. COLLECTOR, DYE #1          2. COLLECTOR, #1          3. COLLECTOR, #2          4. COLLECTOR, #2          5. COLLECTOR, #3          6. COLLECTOR, #3          7. COLLECTOR, #4          8. COLLECTOR, #4          9. BASE, #4          10. EMITTER, #4          11. BASE, #3          12. EMITTER, #3          13. BASE, #2          14. EMITTER, #2          15. BASE, #1          16. EMITTER, #1</p>
<p><b>STYLE 5:</b></p> <p>PIN 1. DRAIN, DYE #1          2. DRAIN, #1          3. DRAIN, #2          4. DRAIN, #2          5. DRAIN, #3          6. DRAIN, #3          7. DRAIN, #4          8. DRAIN, #4          9. GATE, #4          10. SOURCE, #4          11. GATE, #3          12. SOURCE, #3          13. GATE, #2          14. SOURCE, #2          15. GATE, #1          16. SOURCE, #1</p>	<p><b>STYLE 6:</b></p> <p>PIN 1. CATHODE          2. CATHODE          3. CATHODE          4. CATHODE          5. CATHODE          6. CATHODE          7. CATHODE          8. CATHODE          9. ANODE          10. ANODE          11. ANODE          12. ANODE          13. ANODE          14. ANODE          15. ANODE          16. ANODE</p>	<p><b>STYLE 7:</b></p> <p>PIN 1. SOURCE N-CH          2. COMMON DRAIN (OUTPUT)          3. COMMON DRAIN (OUTPUT)          4. GATE P-CH          5. COMMON DRAIN (OUTPUT)          6. COMMON DRAIN (OUTPUT)          7. COMMON DRAIN (OUTPUT)          8. SOURCE P-CH          9. SOURCE P-CH          10. COMMON DRAIN (OUTPUT)          11. COMMON DRAIN (OUTPUT)          12. COMMON DRAIN (OUTPUT)          13. GATE N-CH          14. COMMON DRAIN (OUTPUT)          15. COMMON DRAIN (OUTPUT)          16. SOURCE N-CH</p>	

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<b>DESCRIPTION:</b>	<b>SOIC-16 9.90X3.90X1.50 1.27P</b>	<b>PAGE 2 OF 2</b>

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